

COMBINED DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

This declaration is of the following type:

- ☒ original
- ☐ design
- ☐ supplemental
- ☐ national stage of PCT
- ☐ divisional
- ☐ continuation
- ☐ continuation-in-part (CIP)

My residence, post office address and citizenship are as stated next to my name.

I believe I am the original, first and solo inventor (if only one names is listed below) or an original, first and joint inventor (if plural name are listed below) of the subject matter which is claimed for and for which a patent is sought on the invention entitled:

Silsesquioxane Polymer Molding and Method of Preparing Same

the specification of which

- ☒ is attached hereto
- ☐ was filed on \_\_\_\_\_, as  
Application Serial No. \_\_\_\_\_  
and was amended on \_\_\_\_\_  
(if applicable)

- ☐ was described and claimed in PCT International  
Application No. \_\_\_\_\_ filed on \_\_\_\_\_  
and as amended under PCT Article 19 on \_\_\_\_\_  
(if any).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any Amendment referred to above.

I acknowledge duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, Sec. 1.56.

- ☐ In compliance with this duty there is attached an information disclosure statement. 37 CFR 1.97.

I hereby claim foreign priority benefits under Title 35, United States Code, Sec. 119, of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent of inventor's certificate having a filing date before that of the application on which priority is claimed:

[ ] no such applications have been filed  
[X] such applications have been filed as follows

Prior Foreign Application(s)				
2001-091159	Japan	27/3/2001	[X]	[ ]
(Number)	(country)	(day/month/year filed)	Yes	No
			[ ]	[ ]
(Number)	(country)	(day/month/year filed)	Yes	No
			[ ]	[ ]
(Number)	(country)	(day/month/year filed)	Yes	No

I hereby claim the benefit under Title 35, United States Code, Sec. 120 of any United States application(s) listed below, and insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provide by the first paragraph of Tile 35, United States Code, Sec. 112, I acknowledge the duty to disclose all information known to be material to patentability as defined in Title 37, Code of Federal Regulations, Sec. 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)	(Filing Date)	(patent, pending, abandoned)
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POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agents to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

George A. Loud, Reg. No. 25,814

Anthony M. Lorusso, Reg. No. 25,059

Send correspondence to:  
LORUSSO & LOUD  
3137 Mt. Vernon Avenue  
Alexandria, VA 22305

Direct Telephone calls to:  
George A. Loud  
(703) 739-9393

I hereby declare all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor Toshiaki KOBAYASHI

Inventor's signature Toshiaki Kobayashi February 22, '02(Date)

Residence Ushiku-shi, Ibaraki-ken, Japan

Citizenship Japanese

Post Office Address c/o Tsukuba Center, National Institute of Advanced Industrial Science and Technology of 1-1, Higashi 1-chome, Tsukuba-shi, Ibaraki-ken, Japan

Full name of second inventor, if any Teruyuki HAYASHI

Inventor's signature Teruyuki Hayashi February 22, '02(Date)

Residence Matsudo-shi, Chiba-ken, Japan

Citizenship Japanese

Post Office Address c/o Tsukuba Center, National Institute of Advanced Industrial Science and Technology of 1-1, Higashi 1-chome, Tsukuba-shi, Ibaraki-ken, Japan

Full name of third inventor, if any Masato TANAKA

Inventor's signature Masato Tanaka February 22, '02(Date)

Residence Ota-ku, Tokyo, Japan

Citizenship Japanese

Post Office Address c/o Tsukuba Center, National Institute of Advanced Industrial Science and Technology of 1-1, Higashi 1-chome, Tsukuba-shi, Ibaraki-ken, Japan